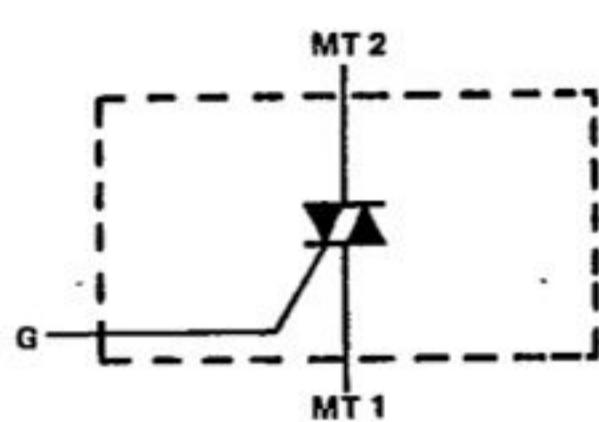
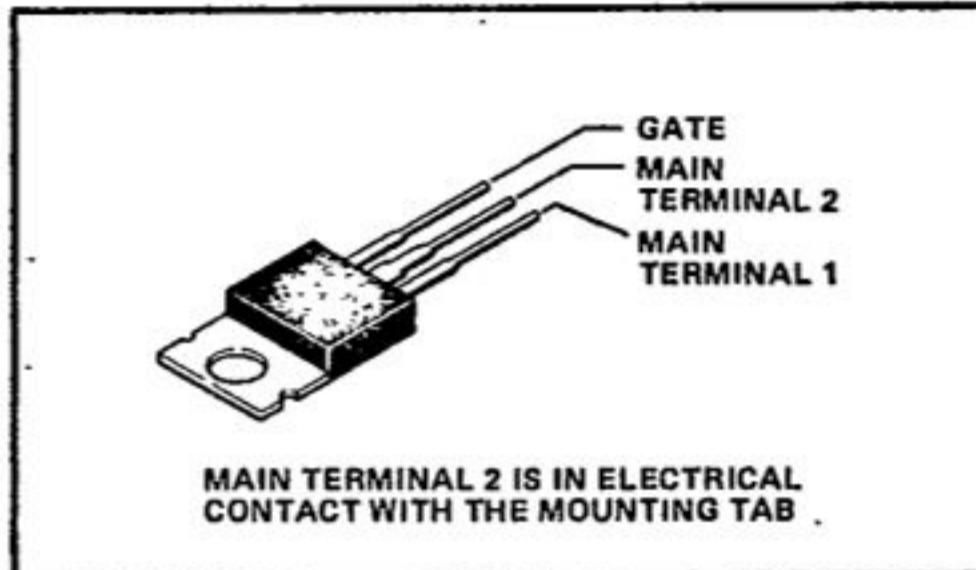


- High-Current Triacs
- 100 V to 800 V
- 12 A and 16 A RMS
- 100 A and 125 A Peak Current
- Max I_{GT} of 50 mA (Quadrants 1-3)

device schematic



TO-220AB PACKAGE



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	SUFFIX	SERIES	
		TIC253	TIC263
Repetitive peak off-state voltage, V_{DRM} (see Note 1)	A	100V	100V
	B	200V	200V
	C	300V	300V
	D	400V	400V
	E	500V	500V
	M	600V	600V
	S	700V	700V
	N	800V	800V
Full-cycle RMS on-state current at (or below) 70°C case temperature $I_T(RMS)$ (see Note 2)		20A	25A
Peak on-state surge current, full-sine-wave, I_{TSM} (see Note 3)		150A	175A
Peak gate current, I_{GM}		$\pm 1\text{A}$	
Operating case temperature range		-40°C to 110°C	
Storage temperature range		-40°C to 110°C	
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds		230°C	

- NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.
 2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 500 mW/°C for Series TIC253 and 625 mW/°C for Series TIC263.
 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) rated values of peak reverse voltage and on-state current. Surge may be repeated after the device has returned to original thermal equilibrium.

SERIES TIC253, TIC263 SILICON TRIACS

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SERIES TIC253			SERIES TIC263			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
I _{DRM}	Repetitive Peak Off-State Current V_{DRM} = Rated V_{DRM} , $I_G = 0$, $T_C = 100^\circ C$			± 2			± 2	mA
I _{GTM}	$V_{supply} = +12V^\dagger$, $R_L = 10\Omega$, $t_{w(g)} \geq 20\mu s$		7	50	7	50		mA
	$V_{supply} = +12V^\dagger$, $R_L = 10\Omega$, $t_{w(g)} \geq 20\mu s$		-15	-50	-15	-50		
	$V_{supply} = -12V^\dagger$, $R_L = 10\Omega$, $t_{w(g)} \geq 20\mu s$		-16	-50	-16	-50		
	$V_{supply} = -12V^\dagger$, $R_L = 10\Omega$, $t_{w(g)} \geq 20\mu s$		28		28			
V _{GTM}	$V_{supply} = +12V^\dagger$, $R_L = 10\Omega$, $t_{w(g)} \geq 20\mu s$		0.7	2	0.7	2		V
	$V_{supply} = +12V^\dagger$, $R_L = 10\Omega$, $t_{w(g)} \geq 20\mu s$		-0.7	-2	-0.7	-2		
	$V_{supply} = -12V^\dagger$, $R_L = 10\Omega$, $t_{w(g)} \geq 20\mu s$		-0.8	-2	-0.8	-2		
	$V_{supply} = -12V^\dagger$, $R_L = 10\Omega$, $t_{w(g)} \geq 20\mu s$		0.8	2	0.8	2		
V _{TM}	$I_{TM} = \pm 28.2A$, $I_G = 50mA$, See Note 4		± 1.4	± 1.7				V
	$I_{TM} = \pm 35.2A$, $I_G = 50mA$, See Note 4						± 1.5	
I _H	$V_{supply} = +12V^\dagger$, $I_G = 0$, Initiating $I_{TM} = 100mA$		6	40	6	40		mA
	$V_{supply} = -12V^\dagger$, $I_G = 0$, Initiating $I_{TM} = -100mA$		-13	-40	-13	-40		
I _L	$V_{supply} = +12V^\dagger$, See Note 5		20		20			mA
	$V_{supply} = -12V^\dagger$, See Note 5		-20		-20			
dv/dt	Critical Rate of Rise of Off-State Voltage	V_D = Rated V_D , $T_C = 110^\circ C$		450		450		V/ μs
dv/dt (c)	Critical Rise of Commutation Voltage	V_R = Rated V_D , $di/dt = 0$		1		1		V/ μs
di/dt	Critical Rate of Rise of On-State Current	V_D = Rated V_D , $dI_G/dt = 50mA/\mu s$, $T_C = 110^\circ C$		200		200		A/ μs

[†] All voltages are with respect to Main Terminal 1.

- NOTES: 6. This parameter must be measured using pulse techniques, $t_w \leq 1ms$, duty cycle $\leq 2\%$. Voltage-sensing contacts, separate from the current-carrying contacts, are located within 3.2 mm (1/8 inch) from the device body.
 7. The triacs are triggered by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics:
 $R_G = 100\Omega$, $t_w = 20\mu s$, $t_r \leq 15ns$, $t_f \leq 15ns$, $f = 1\text{kHz}$.

thermal characteristics

PARAMETER	TEST CONDITIONS	SERIES TIC253			SERIES TIC263			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
R _{θJC}			1.52		1.22			°C/W
R _{θJA}			36		36			

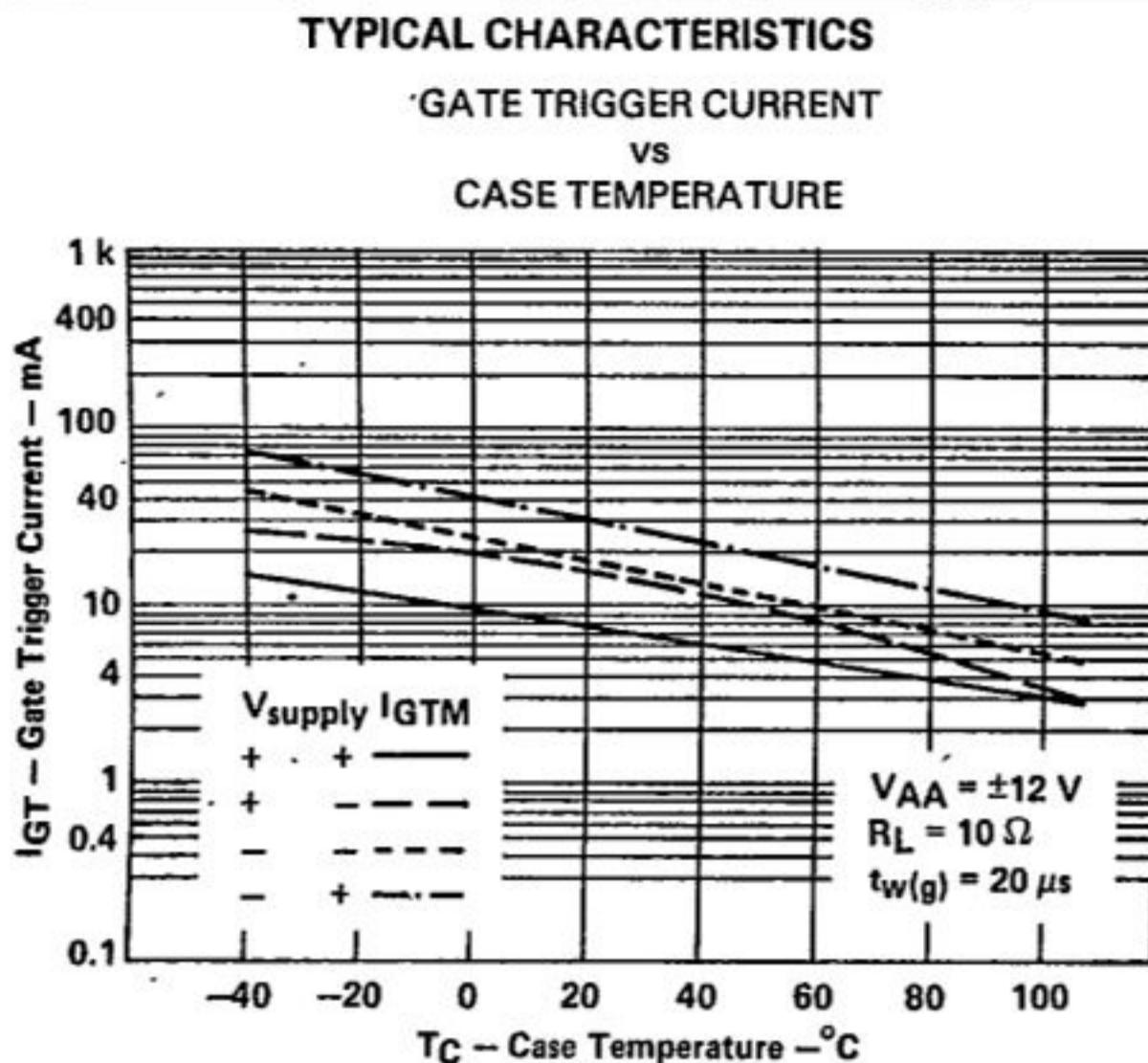


FIGURE 1

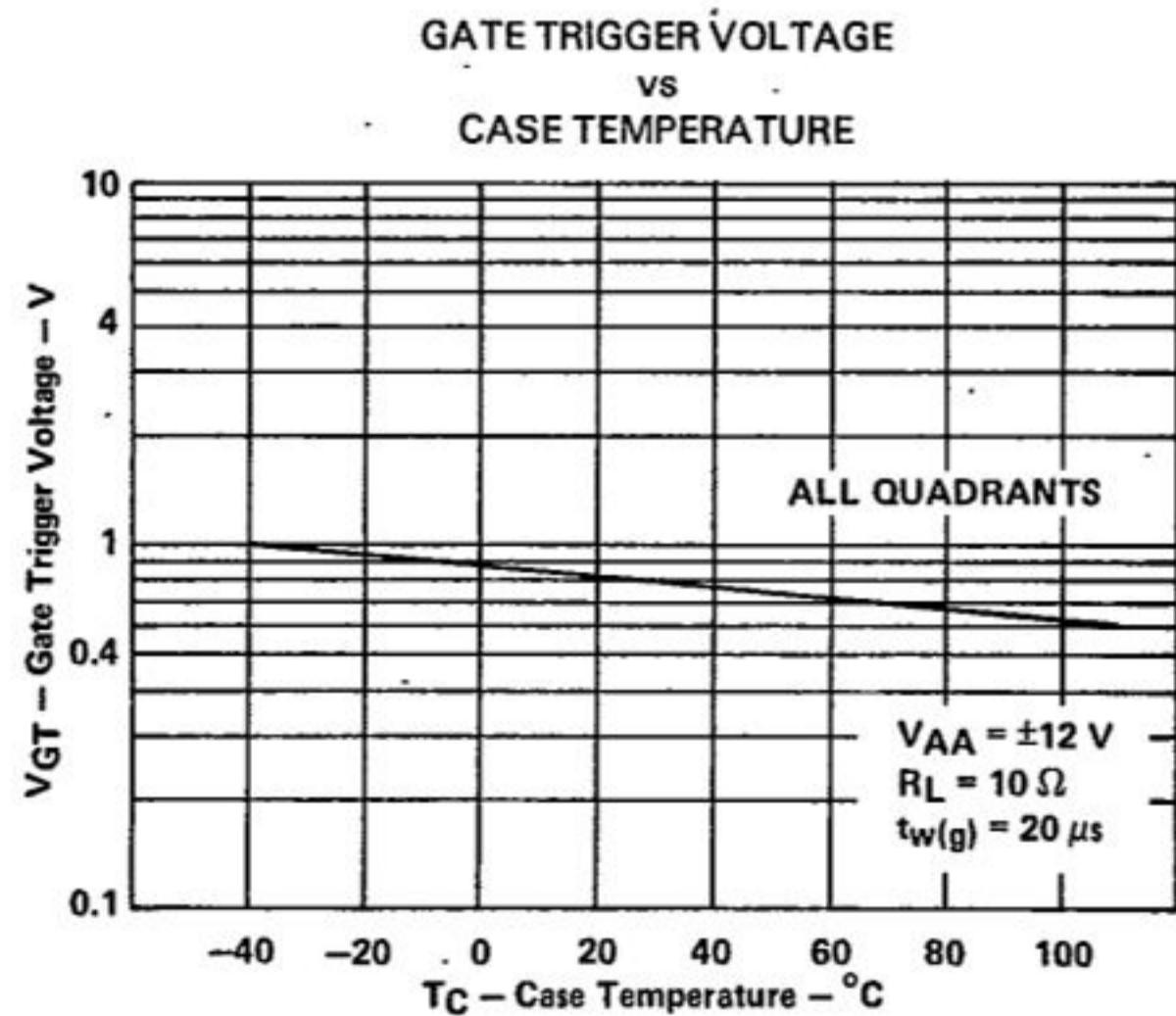


FIGURE 2

4

TIC Devices

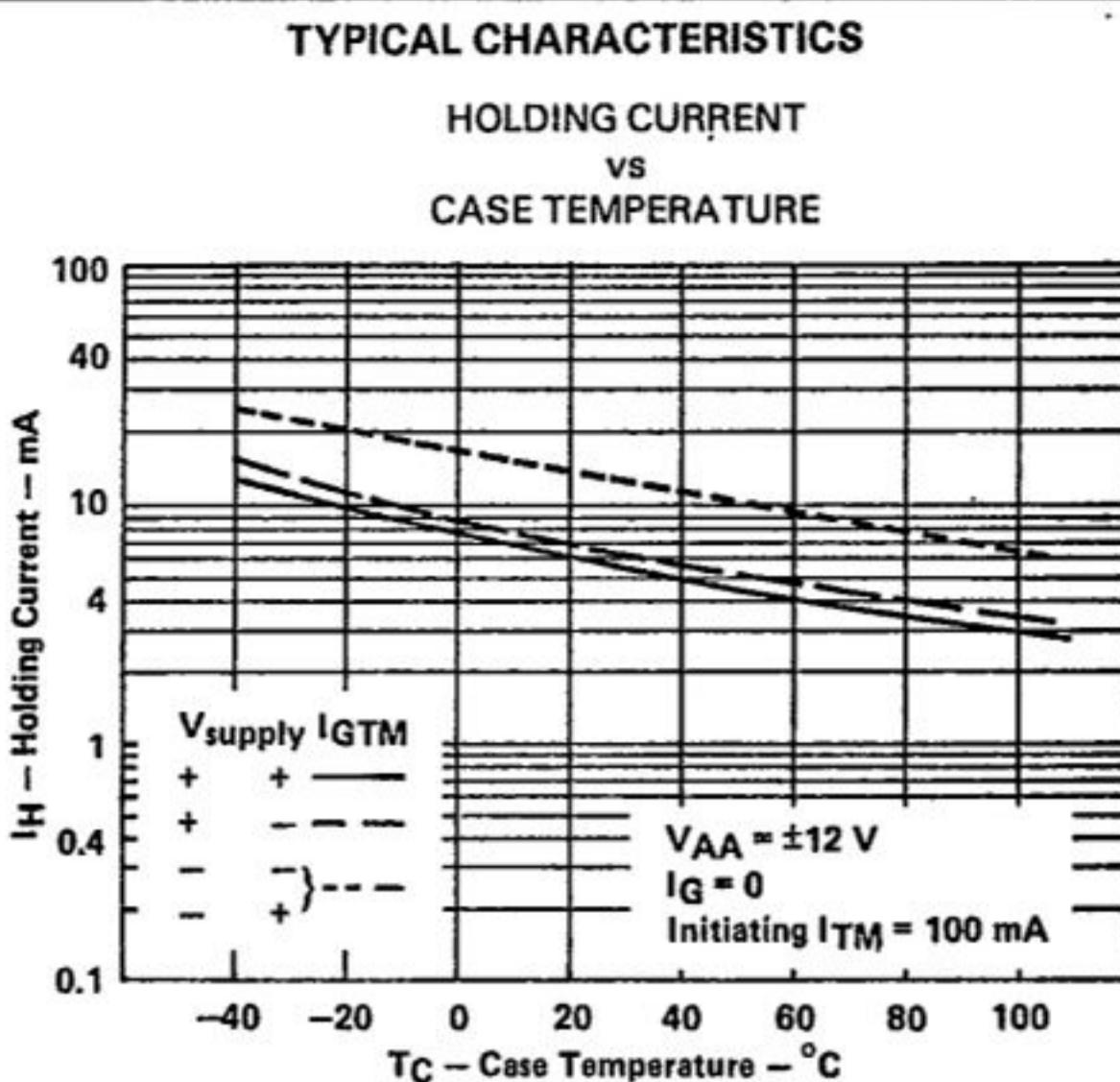


FIGURE 3

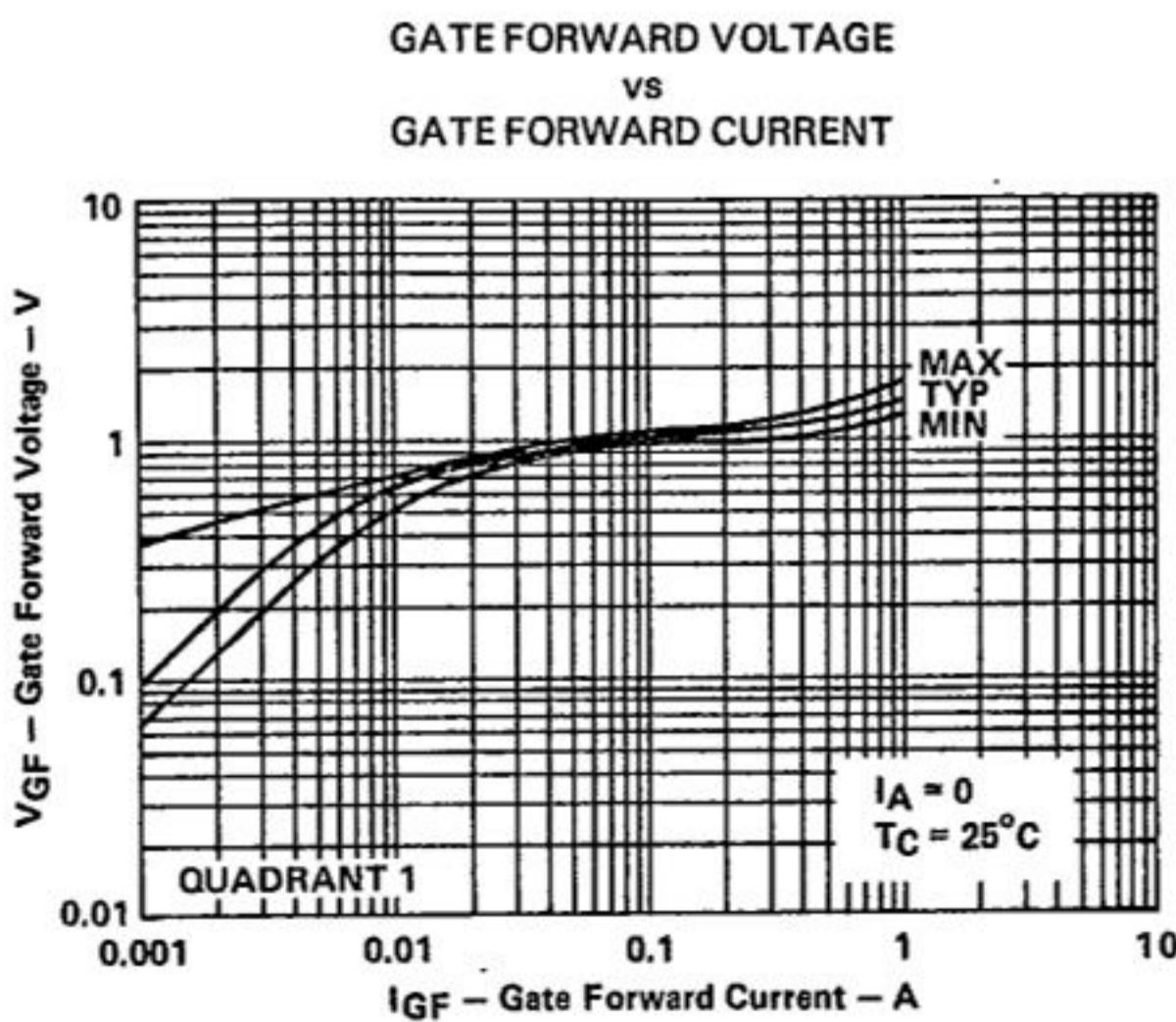


FIGURE 4

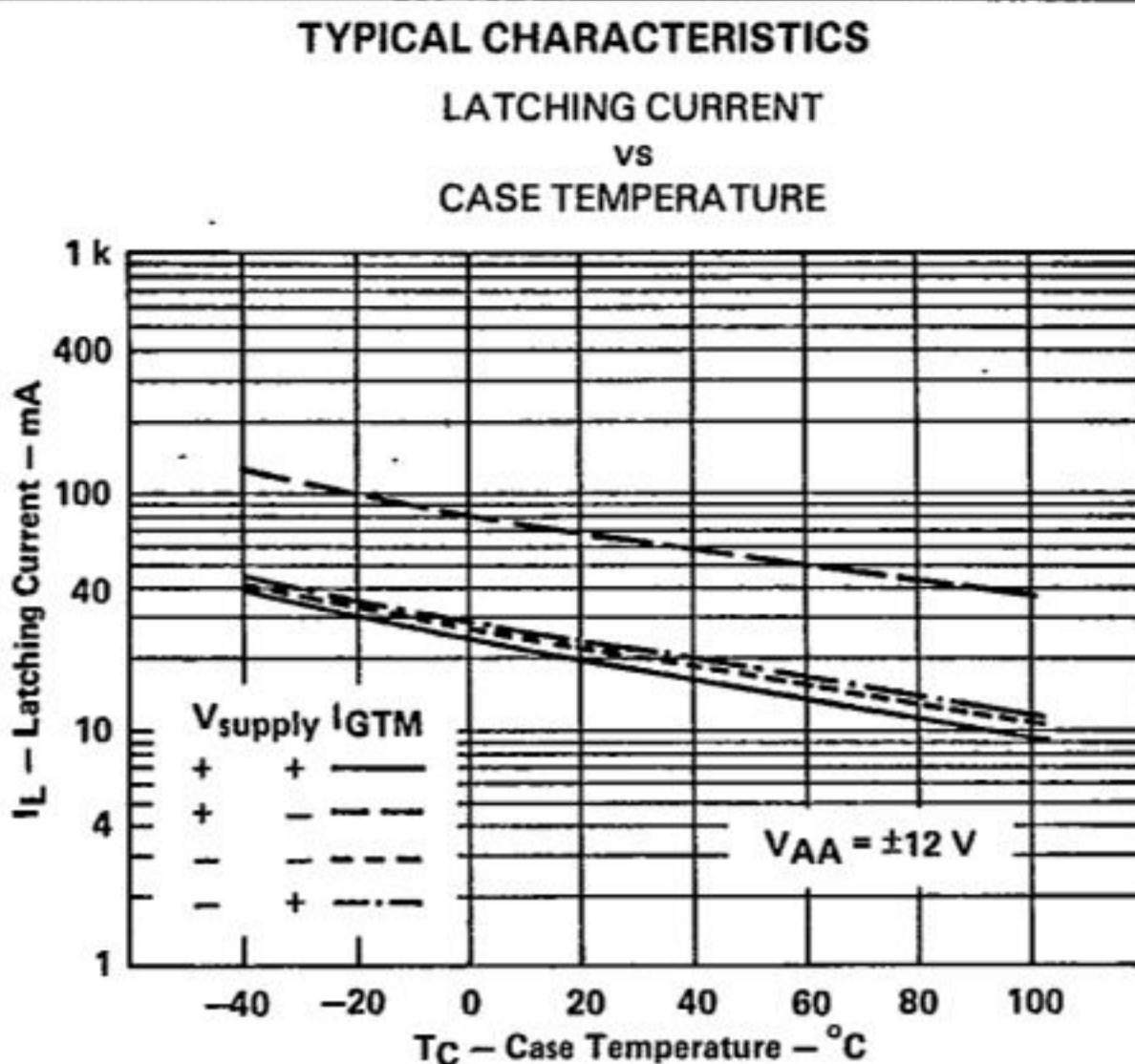
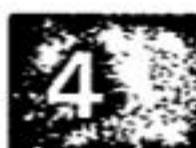


FIGURE 5



TIC₂ Devices